

RECEIVED
CENTRAL FAX CENTER
AUG 17 2005

RESPONSE UNDER 37 CFR 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 2818

PATENT APPLICATION
Docket No.: 8750-045
Client Ref. No.: SPX200306-0020US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: In-Ku KANG

Serial No.: 10/632,700 Examiner: Tran, Mai Huong C.

Filed: July 31, 2003 Group Art Unit: 2818

Confirmation No.: 3617

For: MULTI-CHIP MODULE HAVING BONDING WIRES AND
METHOD OF FABRICATING THE SAME

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER FINAL REJECTION UNDER 37 CFR 1.116

Responsive to the Final Office Action, Paper No. 102005, dated March 22, 2005,
please amend the application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on
page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.

08/18/2005 MBINAS 00000041 10632700

03 FC:1202

150.00 OP

04 FC:1201

200.00 OP

Docket No. 8750-045

Page 1 of 8

Application No. 10/632,700